Declaration for U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, p	oost office address and citizens	hip are as stated below nex	t to my name.			
names are listed (Insert Title) S	d below) of the subject matter that the state of the subject matter that the state of the subject matter that the subject matt	which is claimed and for wh	ed below) or an original, first an nich a patent is sought on the in			
the specification	n of which is attached hereto u	nless the following is check	ted			
	was filed on and	as United States Applica was amended on	tion Number or PCT Internation (if applicable)	nal App	lication	Number
	nat I have reviewed and unders nent referred to above.	tand the contents of the abo	ve-identified specification, incl	uding th	ne claim	(s), as amended
I acknowledge Regulations, §	•	n which is material to pater	ntability as defined in Title 37, C	Code of	Federal	
or inventor's ce		also identified below any fe	e, § 119 (a) - (d) of any foreign oreign application for patent or imed:			
nga nga nga	date bolote and of the applicat	ion for winon priority is ou	miou.	Pri	iority Cl	aimed
(List prior	90220673	Taiwan, R.O.C.	29/11/2001	X	Yes	No
foreign applications,	(Number)	(Conutry)	(Day/Month/Year Filed)		Yes _	
See note A on back of this	(Number)	(Conutry)	(Day/Month/Year Filed)		Yes _	
pagė)	(Number)	(Conutry)	(Day/Month/Year Filed)		Yes _	
	(Number)	(Conutry)	(Day/Month/Year Filed)			
(See note B on	back of this page)	See attached list for ac	ditional prior foreign application	ons		
subject matter of the first paragrapatentability as	of each of the claims of this apraph of Title 35, United Stat	plication is not disclosed in es Code, § 112, I acknow Federal Regulations, § 1.5	ny United States application(s) a the prior United States applicated the duty to disclose info which became available betweetion.	ition in ormatio	the man	ner provided by 1 is material to
(List prior U.S.						
Applications)	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending,	Abando	oned)	
	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending,	Abando	oned)	
	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending,	Abando	oned)	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith:

Raymond J. Ho, Reg. No. 41,838

Please direct all communications to the following address:

the state of

INTELLECTUAL PROPERTY SOLUTIONS, P.L.L.C.

1300 Pennsylvania Avenue, N.W., Suite 700

Washington, D.C. 20004

Telephone: (202)204-3080 Fax: (202)204-3082

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C	Full name of sole or first inventor (given name, family name) Ching-Feng LAI (Last name: LAI)				
above)	Inventor's signature Ching-Feng Lai Date 30/01/2002				
	Residence Taichung, Taiwan, R.O.C. Citizenship Taiwan, R.O.C.				
	Post Office Address No.22, Lane 225, Han-Koh Rd. Sec.2, Taichung, Taiwan, R.O.C.				
Full name of second	inventor (given name, family name) Chun-Chung YANG (Last name: YANG)				
	Chun Chung Gang Date 30/01/2002				
Residence Hsinch					
: **:	No.28, Lane 456, Ming-Hu Rd., Hsinchu, Taiwan, R.O.C.				
Full name of third in	nventor (given name, family name) Yu-Chuong CHANG (Last name: CHANG)				
Inventor's signature	Ju-charge charf Date 30/01/2002				
Residence Hsinch	u Hsien, Taiwan, R.O.C. Citizenship Taiwan, R.O.C.				
Post Office Address	No.11, Lane 240, Ming-Hsin Rd., Chutung Chen, Hsinchu Hsien, Taiwan, R.O.C.				
Rev. 01/00					
T. A. SHANA					
Titles Security Secur					
5年名					